

Miniature Plastic Fixed Attenuator

50Ω 0.5W 3dB DC to 8000 MHz

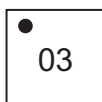
Maximum Ratings

Operating Temperature	-45°C to 85°C
Storage Temperature	-55°C to 100°C
Permanent damage may occur if any of these limits are exceeded.	

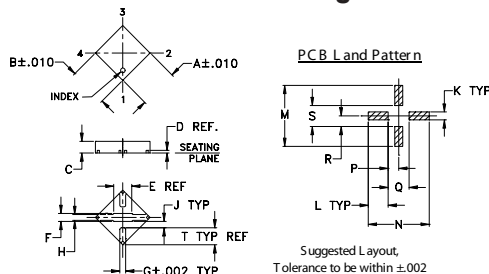
Pin Connections

INPUT	1
OUTPUT	3
GROUND	2,4

Product Marking



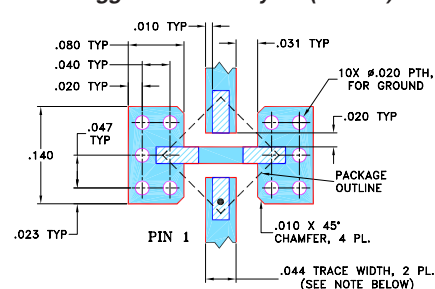
Outline Drawing



Outline Dimensions (inch)

A	B	C	D	E	F	G	H	I	J	K	L	M	N	P	Q	R	S	T	Wt
0.118	0.118	0.035	0.008	0.07	0.024	0.017	0.018	0.021		0.024	0.061	0.186	0.186	0.032	0.064	0.032	0.064	0.05	grams
3.00	3.00	0.89	0.20	1.78	0.61	0.43	0.46	0.53		0.61	1.55	4.72	4.72	0.81	1.63	0.81	1.63	1.27	0.02

Demo Board MCL P/N: TB-154 Suggested PCB Layout (PL-126)



NOTES:

- TRACE WIDTH IS SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .020" ± .0015"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
- BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER)
- DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

Notes

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
- C. The parts covered by this specification document are subject to Mini-Circuits standard limited warranty and terms and conditions (collectively, "Standard Terms"); Purchasers of this part are entitled to the rights and benefits contained therein. For a full statement of the Standard Terms and the exclusive rights and remedies thereunder, please visit Mini-Circuits' website at www.minicircuits.com/MCLStore/terms.jsp

Features

- miniature package MCLP™ 3x3 mm
- specified to 8000 MHz, useable to 10000 MHz
- excellent VSWR, 1:15:1 typ.

Applications

- cellular
- PCS
- communications
- radar
- defense

GAT-3+



Generic photo used for illustration purposes only

CASE STYLE: FG873

+RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

Reel Size	Available Tape and Reel at no extra cost
7"	20, 50, 100, 200, 500, 1000
13"	2000, 3000, 4000

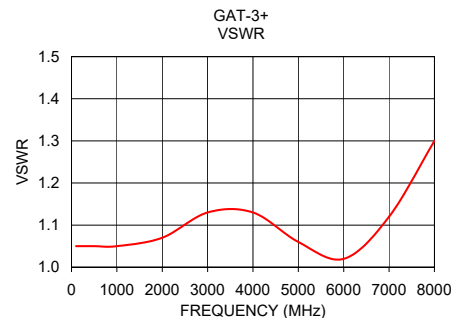
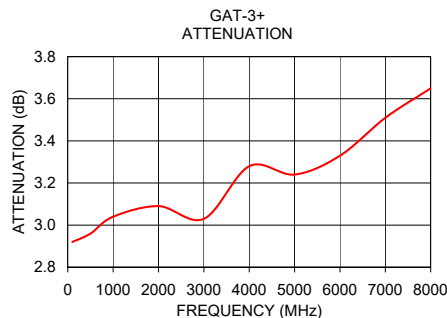
Electrical Specifications at 25°C

FREQ. RANGE (MHz)	ATTENUATION (dB)						VSWR (:1)						MAX. INPUT POWER ¹ (W)
	Flatness												
	DC-1		1-5		5-8		DC-1		1-5		5-8		
	GHz		GHz		GHz		GHz		GHz		GHz		
f _L -f _U	Nom.	Typ.	Typ.	Typ.	Typ.	Typ.	Max.	Typ.	Max.	Typ.	Max.	Typ.	
DC-8000	3±0.3	0.1	0.2	0.2		1.05	1.2	1.15	1.3	1.35		0.5	

- RF power at 25°C case temperature: ½Watt. Derate linearly to 0.2 Watt at 85°C.
- Flatness= variation over band divided by 2

Typical Performance Data

Frequency (MHz)	Attenuation (dB)	VSWR (:1)
100.00	2.92	1.05
500.00	2.96	1.05
1000.00	3.04	1.05
2000.00	3.09	1.07
3000.00	3.03	1.13
4000.00	3.28	1.13
5000.00	3.24	1.06
6000.00	3.33	1.02
7000.00	3.51	1.12
8000.00	3.65	1.30



Typical Performance Data

FREQUENCY (MHz)	ATTENUATION (dB)	RETURN LOSS (dB)
100.00	2.92	32.26
500.00	2.96	32.26
1000.00	3.04	32.26
2000.00	3.09	29.42
3000.00	3.03	24.29
4000.00	3.28	24.29
5000.00	3.24	30.71
6000.00	3.33	40.09
7000.00	3.51	24.94
8000.00	3.65	17.69

REV. X1

GAT-3+

061107

Page 1 of 1



IF/RF MICROWAVE COMPONENTS • ISO 9001 ISO 14001 AS 9100 CERTIFIED RoHS compliant

P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661

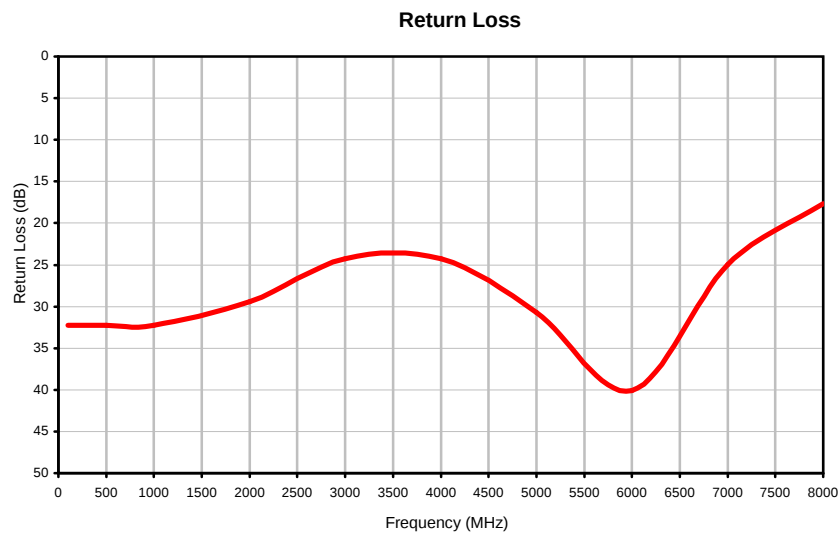
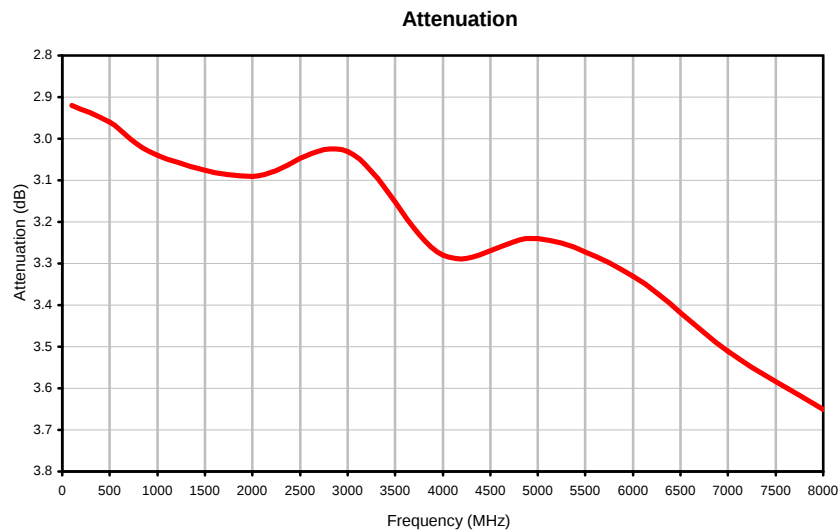


Patent Pending

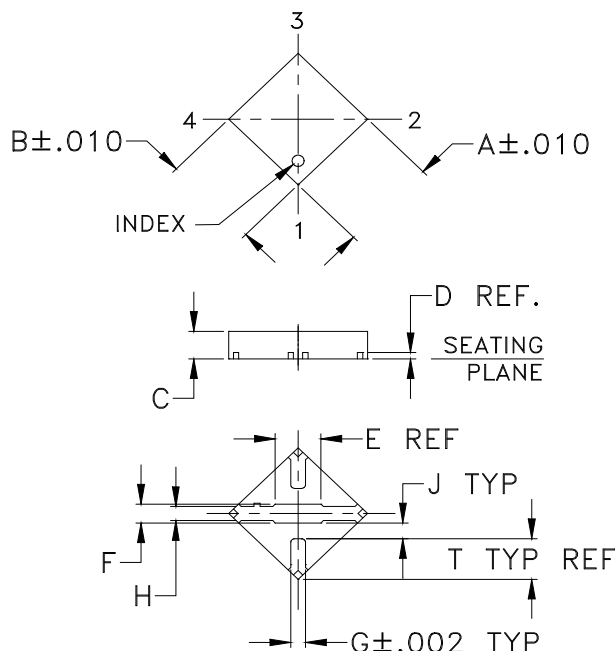
The Design Engineers Search Engine finds the model you need, Instantly • For detailed performance specs & shopping online see



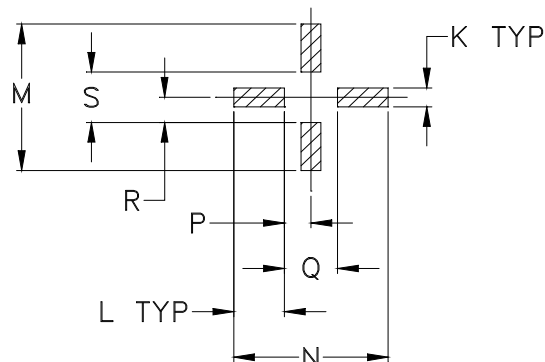
Typical Performance Curves



Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

CASE #	A	B	C	D	E	F	G	H	J	K	L	M	N	P
FG873	.118 (3.00)	.118 (3.00)	.035 (0.89)	.008 (0.20)	.07 (1.78)	.024 (0.60)	.017 (0.43)	.018 (0.46)	.021 (0.52)	.024 (0.61)	.061 (1.55)	.186 (4.72)	.186 (4.72)	.032 (0.81)

CASE #	Q	R	S	T	WT. GRAM
FG873	.064 (1.63)	.032 (0.81)	.064 (1.63)	.050 (1.27)	.02

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3Pl. $\pm .004$

Notes:

- Case material: Plastic.
- Termination finish:
For RoHS Case Styles: Tin-Silver alloy plate over Nickel barrier or Matte-Tin per Data Sheet.
All models, (+) suffix.
For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.



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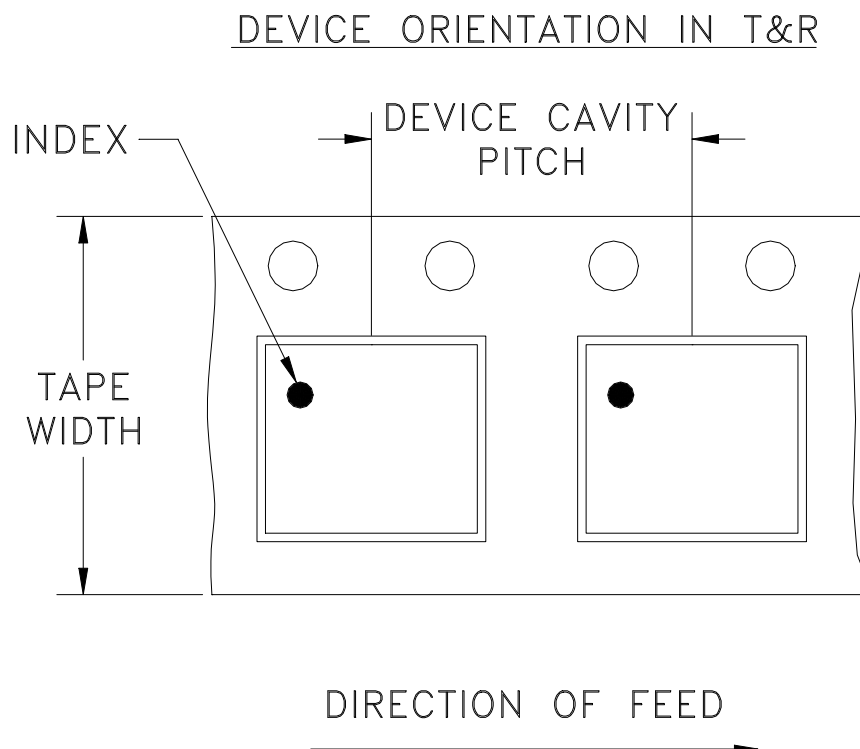


Provides ACTUAL Data Instantly From MINI-CIRCUITS At: www.minicircuits.com

RF/IF MICROWAVE COMPONENTS



Tape & Reel Packaging TR-F68



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note	
12	8	7	Small quantity standard	20
				50
				100
				200
				500
		7	Standard	1000
		13	Standard	2000
				3000
				4000

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf

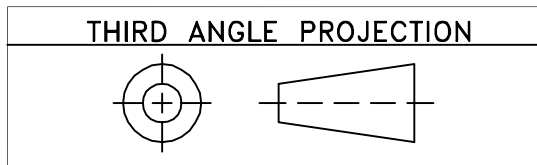


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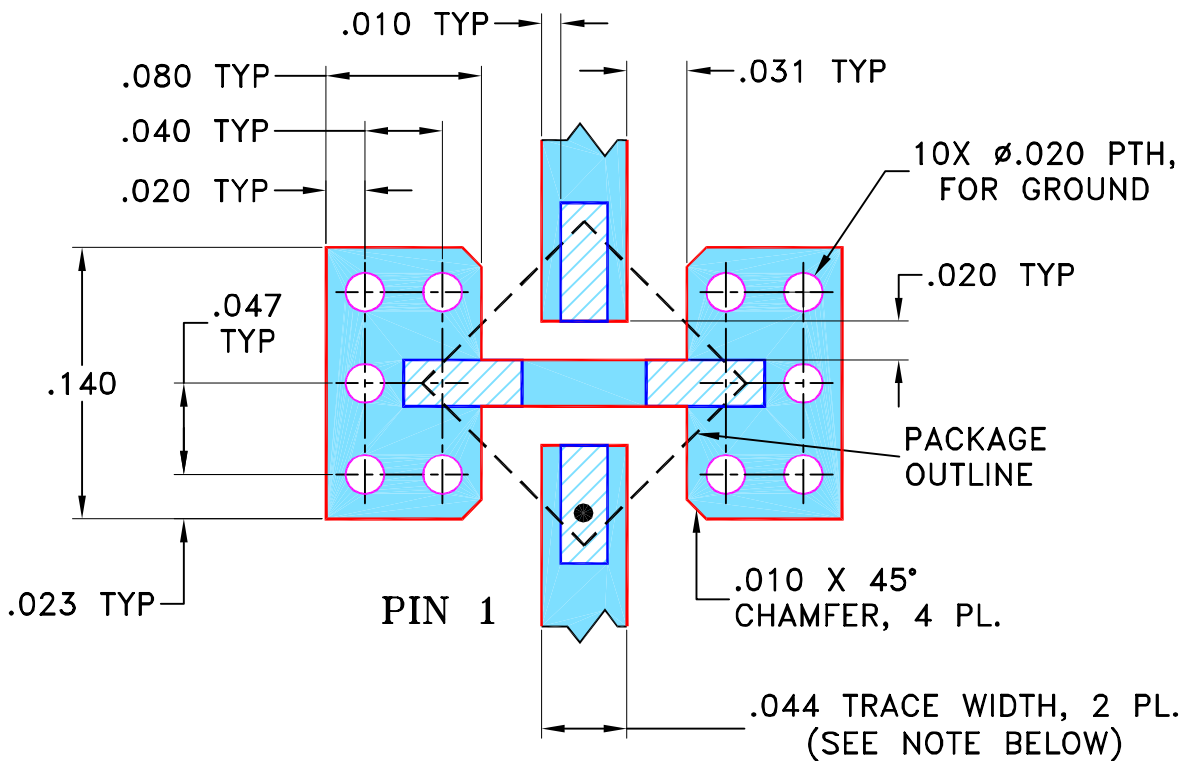
INTERNET <http://www.minicircuits.com>

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REVISIONS					
REV	ECN No.	DESCRIPTION	DATE	DR	AUTH
OR	M85378	NEW RELEASE	02/12/03	MMG	MM
A	M102713	ADDED "... WITH SMOBC"	10/27/06	MMG	MM
B	M108435	REMOVED "CB" PIN CONN AND "LEE"	11/14/06	PW	IG

SUGGESTED MOUNTING CONFIGURATION FOR FG873 CASE STYLE, "hl" PIN CONNECTION



NOTES:

1. TRACE WIDTH IS SHOWN FOR ROGERS R04350B WITH DIELECTRIC THICKNESS .020" ± .0015"; COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH MAY NEED TO BE MODIFIED.
2. BOTTOM SIDE OF THE PCB IS CONTINUOUS GROUND PLANE.

DENOTES PCB COPPER LAYOUT WITH SMOBC
(SOLDER MASK OVER BARE COPPER)

DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK

UNLESS OTHERWISE SPECIFIED	INITIALS		DATE
DIMENSIONS ARE IN INCHES TOLERANCES ON: 2 PL DECIMALS ± 3 PL DECIMALS ± .005 ANGLES ± FRACTIONS ±	DRAWN	MMG	02/06/03
	CHECKED	AY	02/10/03
	APPROVED	MM	02/12/03

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Brooklyn NY 11235

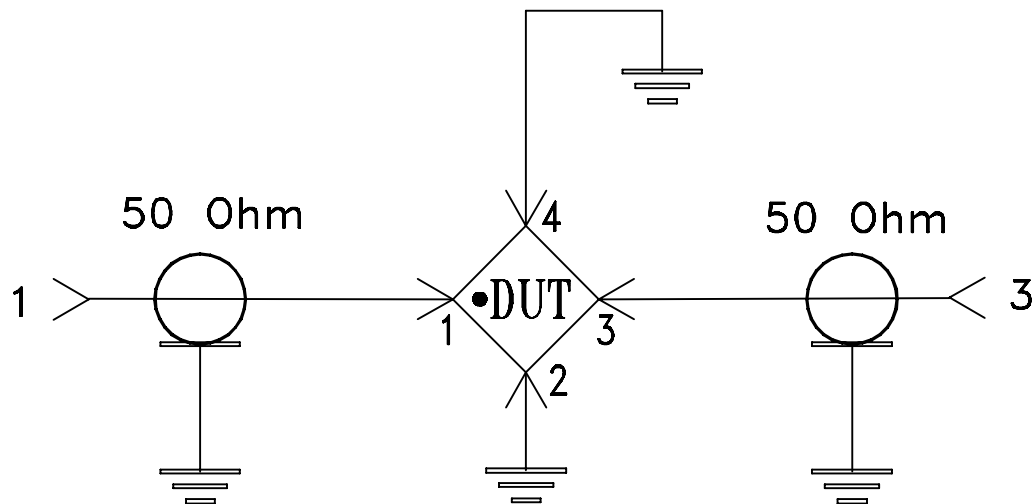
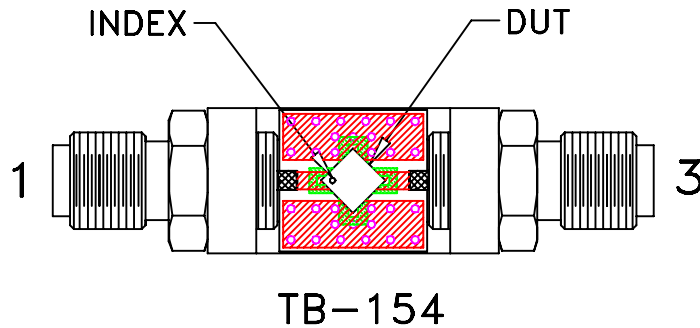
PL, hl, FG873, GAT, TB-154

SIZE A	CODE IDENT 15542	DRAWING NO: 98-PL-126	REV: B
FILE: 98PL126		SCALE: 10:1	SHEET: 1 OF 1

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Characterization Test Board

For Pins Connections refer to Data Sheet of the DUT



Schematic Diagram

Notes:

1. SMA Female connectors.
2. PCB Material: Rogers R04350 or equivalent,
Dielectric Constant=3.5, Thickness=.020 inch.

 **Mini-Circuits®**



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-45° to 85°C or -40° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Mechanical Shock	1.5Kg, 0.5 ms, 5 shock pulses, Y1 direction only	MIL-STD-883, Method 2002, Condition B, except Y1 direction only
Vibration (Variable Frequency)	50g peak	MIL-STD-883, Method 2007, Condition B
Autoclave	15 psig, 100% RH, 121°C, 96 hours	JESD22-A102, Condition C
HAST	130°C, 85% RH, 96 hours	JESD22-A110
Solderability	10X Magnification	J-STD-002, Para 4.2.5, Test S, 95% Coverage
Solder Reflow Heat	Sn-Pb Eutetic Process: 240°C peak Pb-Free Process: 260°C peak	J-STD-020, Table 4-1, 4-2 and 5-2; Figure 5-1
Moisture Sensitivity: Level 1	Bake at 125°C for 24 hours Soak at 85°C/85% RH for 168 hours, Reflow 3 cycles at 260°C peak	J-STD-020
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether +	MIL-STD-202, Method 215



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
	monoethanolamine at 63°C to 70°C	